

Device Specification

ELECTRICAL CHARACTERISTICS



Part Number	I _{hold} (A)	I _{trip} (A)	V _{max} (Vdc)	I _{max} (A)	P _{d typ} (W)	Maximum Time To Trip		Resistance	
						Current (A)	Time (Sec.)	R _{min} (Ω)	R _{1max} (Ω)
SMD2920P200TF/24	2.00	4.00	24	40	1.50	8.00	5.00	0.050	0.125

Note: I_{hold} = Hold current: maximum current device will pass without tripping in 23 °C still air.

I_{trip} = Trip current: minimum current at which the device will trip in 23 °C still air.

V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})

P_{d typ} = Typical power dissipated from device when in the tripped state at 23 °C still air.

R_{min} = Minimum resistance of device in initial (un-soldered) state.

R_{1max} = Maximum resistance of device at 23 °C measured one hour after tripping or reflow soldering of 260 °C for 20 sec.

*Value specified were determined using the PWB with 0.150" * 1.5oz copper traces.

*Customer should verify the device performance in their specified conditions.

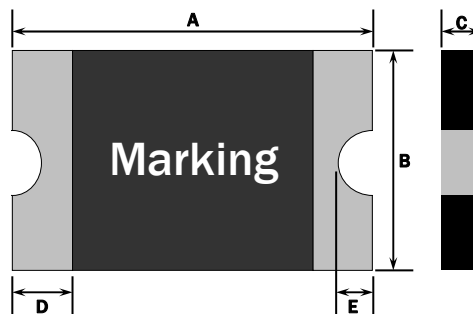
Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

Recognitions:

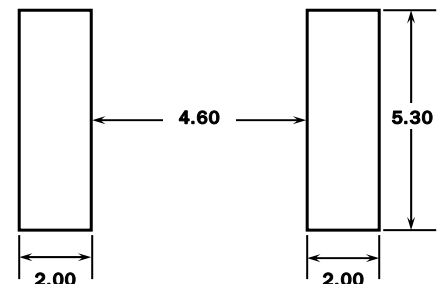
Marking

Polytronics / Polystar Logo
P₂₀₂₄
 Part Identification

Figure



Recommended Pad Layout (mm)



Note: Polystar is Polytronics's manufacturing site in China. The Polystar ID marking shall appear on smallest package.

PHYSICAL DIMENSIONS (mm)

Part Number	A		B		C		D		E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
SMD2920P200TF/24	6.73	7.98	4.80	5.44	0.75	1.25	0.30	2.50	0.25	2.00

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